

SPECIFICATION FOR APPROVAL

CUSTOMER	_____
CUST. PART NO.	_____
CUST. DOC. REV.	_____
DESCRIPTION	CHIP INDUCTORS(RoHS+H.F.)
SAMPLE LOT NO.	_____
PART NO.	FL252009E-XXXM-LRH
DOC. REV.	ORIG
DATE	_____

Once you approve this part, please sign and return this page to the following marked location.



Customer Signature: _____ Date: _____

This part currently development section. Production line can produce this series of products.

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CUSTOMER	CUSTOMER P/N	REV. -	SPL. LOT NO.	
PART NAME CHIP INDUCTORS (RoHS+H.F.)	PART NO. FL252009E-XXXM-LRH	REV. ORIG	DATE OF ISSUE	Q'TY 0 PCS

ENGINEERING CHANGE NOTICE – RECORD

REVISION NO.	REVISION DESCRIPTION	AUTHOR	DATE	REMARK
ORIG		<i>Bruce Hsu</i>		

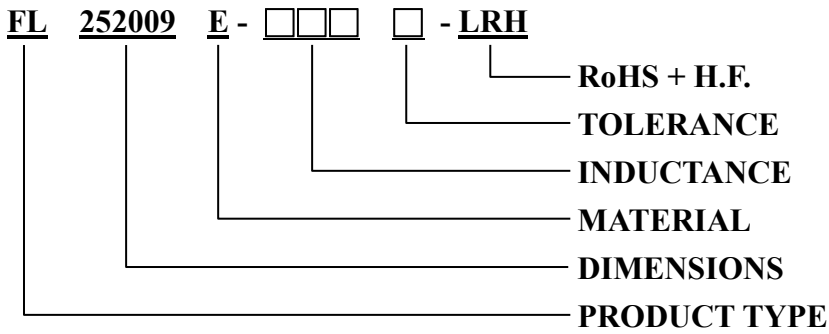


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※This is a RoHS and REACH compliant product whose related documents are available on request.

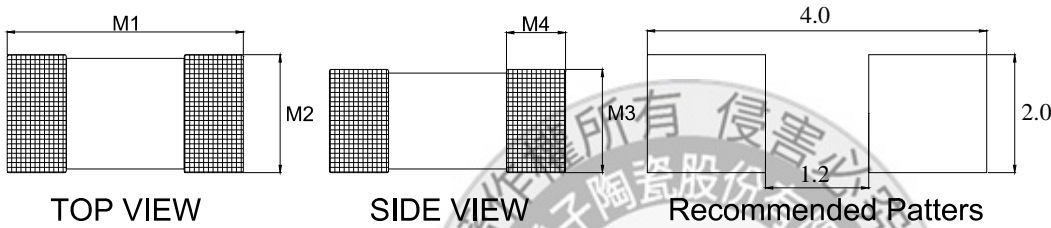
※Graphic is only for dimensionally application.

1. PART NUMBERING IDENTIFICATION



2. MECHANICAL DIMENSION

UNIT: mm



	DIM.	TOL.
M1	2.5	±0.2
M2	2.0	±0.2
M3	0.9	±0.1
M4	0.5	±0.3

3. RATING TEMPERATURE

OPERATING TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

STORAGE CONDITION : LESS THAN 40°C AND 70% RH

STORAGE TIME: 12 MONTHS MAX.

4. TEST INSTRUMENT

4-1. HP4291B-RF Impedance / Material Analyzer

4-2. HP4338A/B Milliohm meter

4-3. OSC Level: 100mV

5. ELECTRICAL SPECIFICATION

Part number	Inductance (μH)	Test Frequency (MHz)	SRF (MHz) MIN.	DC Resistance (Ω) $\pm 25\%$	Rated Current (mA)
FL252009E-R47M-LRH	0.47	1	100	0.040	1800
FL252009E-1R0M-LRH	1.00	1	60	0.055	1600
FL252009E-1R5M-LRH	1.50	1	50	0.070	1500
FL252009E-2R2M-LRH	2.20	1	40	0.080	1300
FL252009E-3R3M-LRH	3.30	1	30	0.100	1200
FL252009E-4R7M-LRH	4.70	1	25	0.110	1100
FL252009E-6R8M-LRH	6.80	1	25	0.200	1100

NOTE:

1. Tolerance: M:±20%

2. Apply DC 0.4 ~ 0.6A to chip for 1 ~ 3 sec. before to measure inductance.

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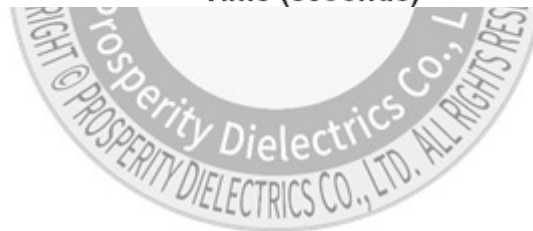
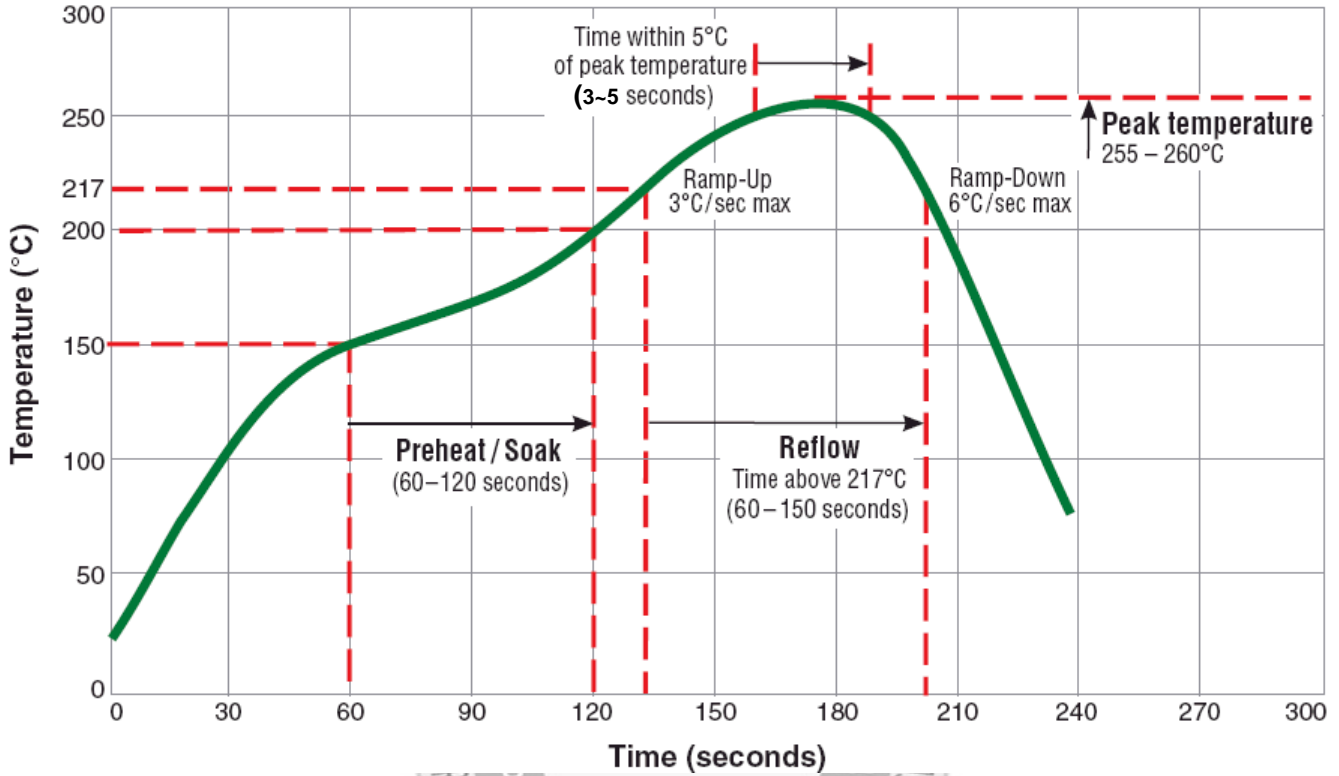
6. RELIABILITY PERFORMANCE

Item	Test Condition	Requirements
Resistance to Solder Heat	<ol style="list-style-type: none"> Solder temperature: 260±5°C Flux: Rosin DIP time: 10±1 sec 	<ol style="list-style-type: none"> More than 95% of terminal electrode should be covered with new solder No mechanical damage Inductance value should be within ±20% of the initial value <p>* Apply DC 0.4 ~ 0.6A to chip for 1 ~ 3 sec. before to measure inductance.</p>
Solderability	<ol style="list-style-type: none"> Solder temperature: 235±5°C Flux: Rosin DIP time: 5±1 sec 	<ol style="list-style-type: none"> More than 95% of terminal electrode should be covered with new solder No mechanical damage
Adhesive Test	<ol style="list-style-type: none"> Reflow temperature: 245°C It shall be Soldered on the substrate applying direction parallel to the substrate Apply force(F): 5 N Test time: 10 sec 	<ol style="list-style-type: none"> No mechanical damage Soldering the products on PCB after the pulling test force > 5 N
Temperature Cycle	<ol style="list-style-type: none"> Temperature: -40 ~ 85°C For 30 minutes each Cycle: 100 cycles Measurement: At ambient temperature 24 hours after test completion 	<ol style="list-style-type: none"> No mechanical damage Inductance should be within ±20% of the initial value <p>* Apply DC 0.4 ~ 0.6A to chip for 1 ~ 3 sec. before to measure inductance</p>
High Temperature Resistance	<ol style="list-style-type: none"> Temperature: 85±5°C Testing time: 1000 hrs Measurement: at ambient temperature 24 hours after test completion 	<ol style="list-style-type: none"> No mechanical damage Inductance should be within ±20% of the initial value <p>* Apply DC 0.4 ~ 0.6A to chip for 1 ~ 3 sec. before to measure inductance.</p>
Humidity	<ol style="list-style-type: none"> Temperature: 40°C±2°C Humidity: 90-95 % RH Testing time: 1000 hrs Measurement: At ambient temperature 24 hours after test completion 	<ol style="list-style-type: none"> No mechanical damage Inductance should be within ±20% of the initial value <p>* Apply DC 0.4 ~ 0.6A to chip for 1 ~ 3 sec. before to measure inductance</p>
Rated Current	At ambient temperature & humidity Testing time: 5 minutes (under full rated current)	Product surface temp: below room temperature plus 40°C

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7. TYPICAL RoHS REFLOW PROFILE

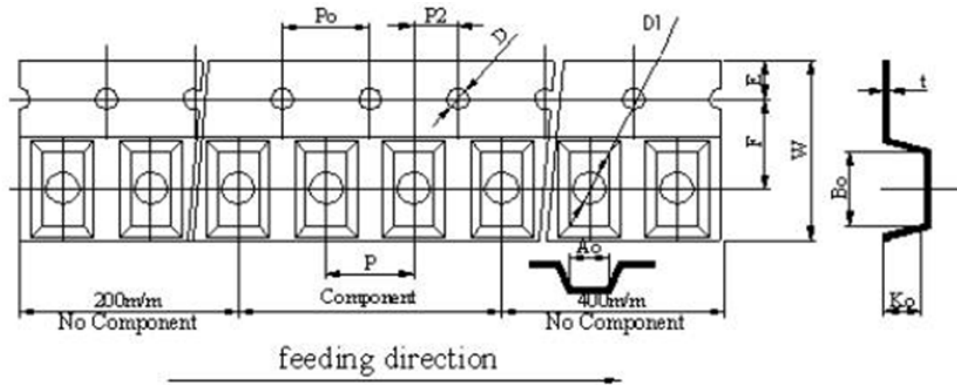
Typical RoHS Reflow Profile



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8. PACKING

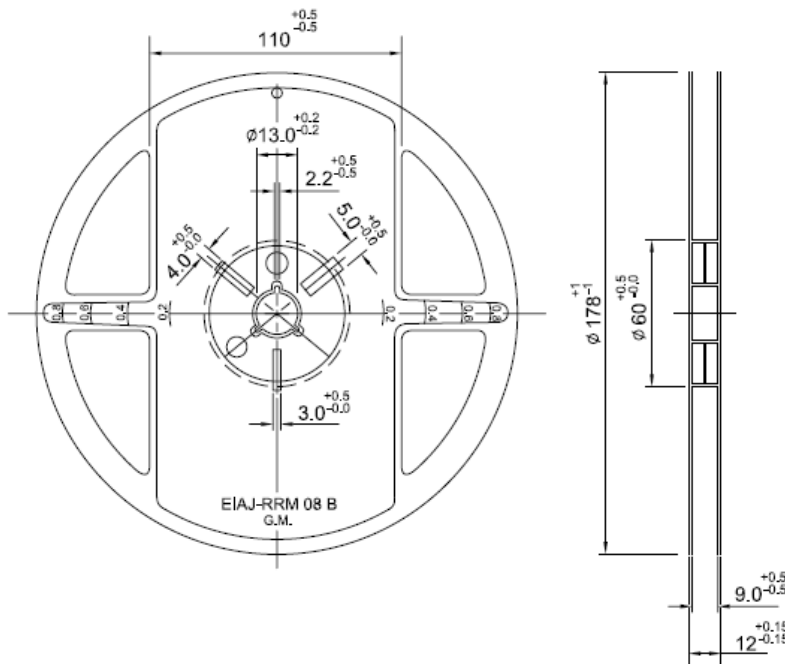
8-1. Plastic Carrier



UNIT: mm

W	P	E	F	D	D1	Po	P2	Ao	Bo	Ko	t
8.00±0.10	4.00±0.10	1.75±0.10	3.50±0.10	1.55±0.05	1.00±0.05	4.00±0.10	2.00±0.10	2.25±0.10	2.80±0.10	1.35±0.10	0.22±0.05

8-2. Reel Dimension (UNIT: mm)



8-3. Packaging Quantity

Qty.	Inner Box
3000 Pcs	5 Reels